# Pressure sintering of Si<sub>3</sub>N<sub>4</sub>

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The sintering of Si<sub>3</sub> N<sub>4</sub> with 5% MgO was investigated at 1450 to 1900° C under a pressure of nitrogen. A maximum density of 95% of the theoretical value was obtained, which is greater than that obtained by pressureless sintering. The sintering process was inferred to be liquid-phase sintering and divided into two processes; rearrangement and solutionprecipitation. The contribution of rearrangement to densification was about 10% in the present system, and the rest, up to 17% was due to solution-precipitation. Application of the present method of sintering Si<sub>3</sub> N<sub>4</sub> with a high strength grain-boundary phase at high temperature is surveyed.

# 1. Introduction

Pressureless sintering of  $Si_3N_4$  with MgO as a sintering aid had already been investigated [1-3]. However,  $Si_3N_4$  of greater than 90% theoretical density was not obtained. In pressureless sintering, maximum density was attained at ~1650°C because although the densification process should be more rapid at higher temperatures, the density was lowered by the weight loss due to thermal decomposition of  $Si_3N_4$  [3, 4].

It has been shown [4] that it is possible to obtain  $Si_3N_4$  of greater than 90% theoretical density by heating compacted  $Si_3N_4$  and MgO under pressure of nitrogen or/and an inert gas at temperatures higher than 1650°C.

In the hot-pressing of  $Si_3N_4$  with MgO, an MgO-SiO<sub>2</sub> liquid phase was obtained [5-9]. In the present method, the same system (in the thermodynamic sense) was used, liquid-phase sintering was assumed and the densification process was analysed on the basis of Kingery's theory [10]. The results were compared with those of pressureless sintering [2,3].

The present work reports an analysis of the effect of MgO on the densification process. Application of the present method for sintering  $Si_3N_4$  was also investigated using other additives.

# 2. Experimental procedures

The result of chemical analysis of  $Si_3N_4^*$  is shown in Table I and the crystalline composition determined by X-ray diffraction was mostly  $\beta$ -Si<sub>3</sub>N<sub>4</sub>

TABLE I	The compositions	of starting	Si <sub>3</sub> N <sub>4</sub>	(wt%)
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Si	N	Fe	Ca	Al	С	0
58.3	38.5	1.3	0.2	0.2	0.1	1.5

(>95%). The amount of oxygen was determined by neutron activation analysis. Laser-microspectrochemical analysis (LMA) showed the existence of small amounts of Mn, Ni, B, Cr, Ti and Cu.

The size and shape of  $Si_3N_4$  powder after mixing MgO is shown in Fig. 1. The  $Si_3N_4$  powder was mixed in ethanol with 5 wt % MgO in an agate mortar for 24h. The mixture was dried and about 1g was pressed in a steel die, 12 mm diameter, under a pressure of 300 kg cm<sup>-2</sup> (~4.3 × 10<sup>3</sup> psi) and then isostatically pressed under 1.5 ton cm<sup>-2</sup> (~2.1 × 10<sup>4</sup> psi). The density of the compact was about 2.18 g cm<sup>-3</sup> (68.3% of theoretical density



Figure 1 Scanning electron micrographs of Si<sub>3</sub> N<sub>4</sub> powder.

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3.19 g cm<sup>-3</sup>). The compact was heated by high frequency induction under a pressure of 10 atm nitrogen for 30 min at 1450 to 1900° C in a high pressure furnace.<sup>†</sup> The carbon crucible, which was also a susceptor, was lined with BN powder to prevent a reaction between  $Si_3N_4$  and carbon. The temperature was measured by an optical pyrometer calibrated at the melting point of Si (1414°C).

After cooling, the compact was weighed and the density obtained by measuring its dimensions with a micrometer.

The effect of other additives on the sintering of  $Si_3N_4$  was also investigated at  $1800^{\circ}C$  for

<sup>†</sup> Arthur D. Little Inc, Massachusetts, USA.

30 min under 10 atm nitrogen. The additives were  $Al_2O_3$ ,  $Y_2O_3$ ,  $Y_2O_3-Al_2O_3$ ,  $La_2O_3$ ,  $Ga_2O_3-Al_2O_3$  and  $AlN-Al_2O_3$ . These additives have been shown to be effective in making dense  $Si_3N_4$  or "sialons" under hot-pressing conditions [11-16].

# 3. Results and discussion

#### 3.1. The effect of MgO

The values of density and weight loss after heating at 1450 to  $1900^{\circ}$ C for 30 min under 10 atm nitrogen are shown in Fig. 2a and b. The results for pressureless sintering of Si<sub>3</sub>N<sub>4</sub> and 5% MgO for 20 min [3] are also plotted in the figure.

 $Si_3N_4$  of up to 93% theoretical density was obtained by the present method. Fig. 2 shows the superiority of this method over pressureless sintering.

In the present method and pressureless sintering, the density and weight loss were initially increased at higher temperatures. The density was then decreased above a certain temperature because it was determined by two countervailing processes, shrinkage and thermal decomposition of  $Si_3N_4$ . They predict an optimum temperature at which the most dense material is obtained. In pressureless sintering, this was  $\sim 1550^{\circ} C$  [3] or  $\sim 1650^{\circ} \text{ C}$  [4, 17]. At lower temperatures shrinkage was dominant, and at higher temperatures thermal decomposition was dominant. On the other hand, the optimum temperature was  $\sim 1800^{\circ}$  C in the present method and the shrinkage was enhanced at temperatures higher than 1650° C.

The shrinkage was due to liquid-phase sintering as for hot-pressing [3]. The densification may be divided into two processes, rearrangement and solution-precipitation [10]. Evidence for two processes is shown below by analysing the results of pressureless sintering [17].

Kingery obtained theoretically the relation between the fractional shrinkage  $(\Delta L/L_0)$  and the time (t) under isothermal conditions for liquidphase sintering [10, 18].

For the rearrangement process, the relation was expressed by,

$$\frac{\Delta L}{L_0} = k_1 t^{1+y}, \qquad (1)$$

where  $k_1$  is a constant and y some small fraction. For the solution-precipitation process,

$$\frac{\Delta L}{L_0} = k_2 r^{-4/3} t^{1/3} = k_3 t^{1/3}, \qquad (2)$$

where  $k_2$  is a constant and r the pore size which was assumed to be constant during sintering [3, 10].

The results of isothermal pressureless sintering of Si<sub>3</sub>N<sub>4</sub> with 5% MgO at 1512, 1540, 1600 and 1673°C [17] are plotted in Fig. 3. The figure shows two stages of densification represented by two straight lines. The slopes for the first stage are 0.63, 0.90 and 0.91 at 1512, 1540 and 1600° C respectively. For the second stage, they are 0.19, 0.31 and 0.34 respectively. The first stage is thought to be the rearrangement process even though the slopes differed from the expected values of 1.3 to 1.4 [18]. The reason for this may be attributed to the difficulty in achieving isothermal conditions in such a short length of time (30 to 50 sec). The second stage is identified as the solution-precipitation process because the slopes are nearly equal to the theoretically predicted value of  $\frac{1}{3}$ .

The amount of liquid phase  $(MgO-SiO_2)$  in present method was assumed to be 7 to 8% because Fe and Al compounds were not included in the grain-boundary phase [7]. The rearrangement process contributed about 10% in densification by Kingery's prediction [10]. This suggests that the melting point of the grain-boundary phase in the present system was 1450 to 1500° C from the results in Fig. 1 and the densification up



Figure 3 Log fractional shrinkage versus log sintering time for isothermal experiments [17].



to  $1500^{\circ}$ C was attributed to the rearrangement process in which Si<sub>3</sub>N<sub>4</sub> particles moved close together in the presence of an MgO–SiO<sub>2</sub> grainboundary liquid phase.

At higher temperature than  $1500^{\circ}$ C, the solution-precipitation process began in which the centre-to-centre distance between particles was decreased by the transfer of materials away from contact points which resulted in further densification.

Further work on this system at  $1800^{\circ}$ C resulted in a density of 2.91 to  $3.04 \text{ g cm}^{-3}$  and a maximum density of 95% of the theoretical value was obtained.

The scanning electron micrographs of fractured surfaces of  $Si_3N_4$  sintered at 1500, 1600 and 1700° C are shown in Fig. 4a to c. At 1500° C, the same size and shape of grains as in the starting powder were observed. This suggests that the shrinkage at this temperature was based on a rearrangement process. At 1600° C, the dissolution of smaller grains and precipitation on larger grains was observed. At 1700° C, however, the size and



Figure 4 Scanning electron micrographs of fractured surfaces of sintered  $Si_3N_4$  at (a) 1500°C, (b) 1600°C, and (c) 1700°C.

shape of the grains were different from those of the starting powder. The results are consistent with the process discussed above.

The characteristic of this method with respect to pressureless sintering was to inhibit thermal decomposition of  $Si_3N_4$  and enabled the use of high temperatures.

### 3.2. The effect of other additives

The effect of other additives on the sintering of  $Si_3N_4$  was surveyed with 5 wt% additives. The results are shown in Table II (in which a combination of two materials signifies a mixture of equal weights). The addition of  $La_2O_3$ ,  $Ga_2O_3$ — $Al_2O_3$  or  $AlN-Al_2O_3$  was least effective; however,  $Al_2O_3$ ,  $Y_2O_3$  or  $Y_2O_3-Al_2O_3$  were most effective and it was possible to densify to greater than 80% of the theoretical value.  $Y_2O_3-Al_2O_3$  was the most interesting because formation of a grainboundary phase with a high melting point, resulting in high strength at high temperatures, was expected [13]. Also, high temperature properties are not sensitive to the presence of impurities

TABLE II The results after sintering at 1800° C for 30 min under 10 atm nitrogen

Additives	Density		Weight loss (%)	
	$g  cm^{-3}$ % theoretical		-	
Y, 0,	2.58	80.9	4.9	
Al <sub>2</sub> O <sub>3</sub>	2.62	82.1	5.2	
$Y_{2}O_{3} - Al_{2}O_{3}$	2.66	83.4	1.3	
$La_2O_3$	2.40	75.2	1.5	
$Ga_2 O_3 - Al_2 O_3$	2.35	73.7	3.5	
AIN-Al <sub>2</sub> O <sub>3</sub>	2.35	73.7	2.0	

which seriously impair the high temperature strength of  $Si_3N_4$  sintered with MgO [13]. The lower density of the  $Y_2O_3$ -Al<sub>2</sub>O<sub>3</sub> system compared to that of MgO was attributed to the high melting point of  $Y_2O_3$ -Al<sub>2</sub>O<sub>3</sub>-SiO<sub>2</sub> grainboundary phases. The high density was expected to be obtained by prolonged heating at 1800° C or at higher temperatures.

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